



RECOMMENDED MOUNTING HOLE  
 MAXIMUM PANEL THICKNESS: 5.5MM

NOTES:

1. MATERIALS:

- ① CENTER CONTACT: PHOSPHOR BRONZE, GOLD PLATING
- ② BODY: ZINC ALLOY, NICKEL PLATING
- ③ INSULATOR: PE-606
- ④ MOUNTING POST: BRASS, TIN PLATING
- ⑤ SOLDER TAIL: BRASS WIRE, TIN PLATING

2. UNSPECIFIED TOLERANCE: .XX ±0.25 [0.010]  
 .X ±0.30 [0.012]

RoHS Compliant

		<small>THE INFORMATION AGE</small>	
<small>XMULTIPLE ASIA          4F, No. 347, Yang Guang St.,          Neihu, Taipei, Taiwan 11475</small>		<small>XMULTIPLE USA          1420 Los Angeles Ave., Suite G,          Simi Valley, CA 93065</small>	
THIS DRAWING IS A CONTROLLED DOCUMENT.		<small>G/NO:</small> XMRF-MCX-007	
<small>TITLE:</small> 50 OHM BNC R/A PCB/PANEL MOUNT JACK, METAL BODY		<small>DWG NO:</small> XMRF-MCX-007	
<small>PART NO:</small> XMRF-MCX-007		<small>LEDN</small>	
		<small>UNIT</small> mm[inch]	<small>SHEET</small> 1 of 1
		<small>REV</small> 02	<small>CHKD:</small> JEFF
			<small>DATE:</small> Sep.20,07